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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

J1040 U.S. PTO
09/910904
07/24/01


In re U.S. Patent Application of)
YASUI et al.)
Application Number: To Be Assigned)
Filed: Concurrently Herewith)
For: PLANARIZING METHOD OF SEMICONDUCTOR)
WAFER AND APPARATUS THEREOF)

**Honorable Assistant Commissioner
for Patents
Washington, D.C. 20231**

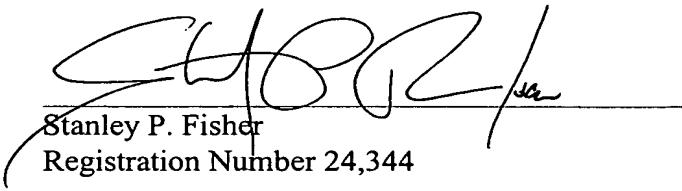
**NOTICE OF PRIORITY
UNDER 35 U.S.C. § 119
AND THE INTERNATIONAL CONVENTION**

Sir:

In the matter of the above-captioned application for a United States patent, notice is hereby given that the Applicant claims the priority date of July 27, 2000, the filing date of the corresponding Japanese patent application 2000-231389.

The certified copy of corresponding Japanese patent application 2000-231389 will be submitted as soon as received from Applicant. Acknowledgment of receipt of the certified copy is respectfully requested in due course.

Respectfully submitted,


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